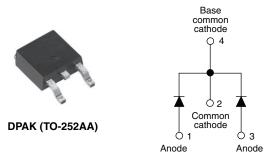
Vishay Semiconductors

COMPLIANT

HALOGEN FREE

High Performance Schottky Rectifier, 2 x 3 A



PRIMARY CHARACTERISTICS					
I _{F(AV)}	2 x 3 A				
V_{R}	50 V, 60 V				
V _F at I _F	0.65 V				
I _{RM} typ.	15 mA at 125 °C				
T _J max.	150 °C				
E _{AS}	6 mJ				
Package	DPAK (TO-252AA)				
Circuit configuration	Common cathode				

FEATURES

- Low forward voltage drop
- Guard ring for enhanced ruggedness and long term reliability
- Popular DPAK outline
- · Center tap configuration
- Small foot print, surface mountable
- High frequency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

DESCRIPTION

The VS-MBRD650CT-M3, VS-MBRD660CT-M3 surface mount, center tap, Schottky rectifier series has been designed for applications requiring low forward drop and small foot prints on PC boards. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform	6	Α			
V _{RRM}		50/60	V			
I _{FSM}	t _p = 5 μs sine	490	A			
V _F	3 A _{pk} , T _J = 125 °C (per leg)	0.65	V			
T _J	Range	-40 to +150	°C			

VOLTAGE RATINGS						
PARAMETER SYMBOL VS-MBRD650CT-M3 VS-MBRD660CT-M3 UNITS						
Maximum DC reverse voltage	V_R	50	60	V		
Maximum working peak reverse voltage	V_{RWM}	30	00	V		

ABSOLUTE MAXIMUM RATINGS							
PARAMETER		SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum average forward	per leg				3.0		
current See fig. 5	per device	e I _{F(AV)} 50 % duty cycle at T _C = 128 °C, rectangular waveform		6	Α		
Maximum peak one cycle non-repetitive surge current See fig. 7		I _{FSM}	5 µs sine or 3 µs rect. pulse	Following any rated load	490	^	
			10 ms sine or 6 ms rect. pulse	condition and with rated V _{RRM} applied	75		
Non-repetitive avalanche energy per leg		E _{AS}	$T_J = 25 ^{\circ}\text{C}$, $I_{AS} = 1 \text{A}$, $L = 12 \text{mH}$		6	mJ	
Repetitive avalanche current per leg		I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		0.6	Α	



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ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS			
		3 A	T 05 %O	0.7			
Maximum forward voltage drop per leg	V (1)	6 A	T _J = 25 °C	0.9	V		
See fig. 1	V _{FM} ⁽¹⁾	3 A	T 405.00	0.65			
		6 A	T _J = 125 °C	0.85			
Maximum various lasks as surrent novies	I _{RM} ⁽¹⁾	T _J = 25 °C	V Dated V	0.1	mA		
Maximum reverse leakage current per leg		T _J = 125 °C	V _R = Rated V _R	30			
Typical reverse leakage current	I _{RM} ⁽¹⁾	T _J = 125 °C	V _R = Rated V _R	15	mA		
Typical junction capacitance per leg	C _T	V _R = 5 V _{DC} (test signal range 100 kHz to 1 MHz), 25 °C		145	pF		
Typical series inductance per leg	L _S	Measured lead to lead 5 mm from package body		5.0	nΗ		
Maximum voltage rate of change	dV/dt	Rated V _R	10 000	V/µs			

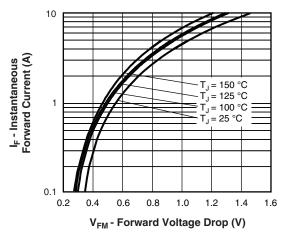
Note

 $^{(1)}\,$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range		T _J ⁽¹⁾ , T _{Stg}		-40 to +150	°C	
Maximum tharmal resistance per leg			DC operation	6		
Maximum thermal resistance, junction to case per devic	per device	R_{thJC}	See fig. 4	3	°C/W	
Maximum thermal resistance, junction to ambient		R _{thJA}		80		
Approximate weight				0.3	g	
				0.01	oz.	
Marking device			Case style DPAK (TO-252AA)	MBRD650C1		
			Case style DEAR (10-232AA)	MBRD660CT		

Note $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$ thermal runaway condition for a diode on its own heatsink

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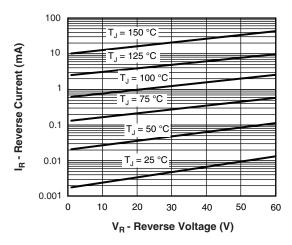


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

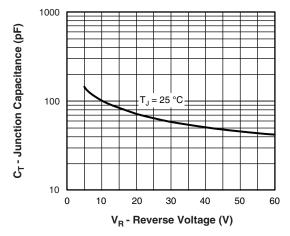


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

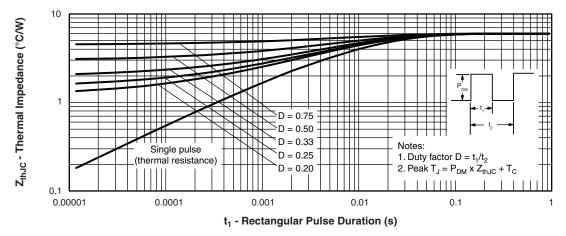


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

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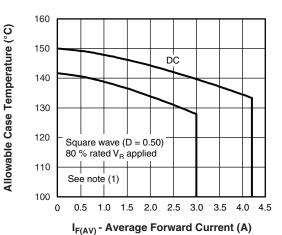


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

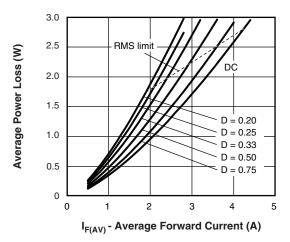


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

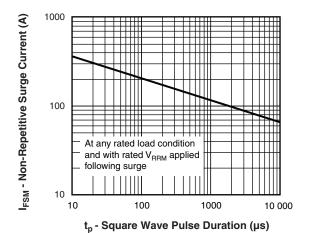


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

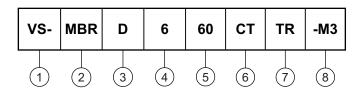
Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{th,JC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_R \text{ (1 - D); } I_R \text{ at } V_{R1} = 80 \text{ \% rated } V_R \\ \end{array}$

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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Schottky MBR series

3 - D = DPAK (TO-252AA)

4 - Current rating (6 = 6 A)

- Voltage ratings

50 = 50 V60 = 60 V

- CT = center tap (dual)

7 - • None = tube

• TR = tape and reel

• TRL = tape and reel (left oriented)

• TRR = tape and reel (right oriented)

8 - Environmental digit:

-M3 = halogen-free, RoHS-compliant and terminations lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-MBRD650CT-M3	75	3000	Antistatic plastic tube			
VS-MBRD650CTTR-M3	2000	2000	13" diameter reel			
VS-MBRD650CTTRL-M3	3000	3000	13" diameter reel			
VS-MBRD650CTTRR-M3	3000	3000	13" diameter reel			
VS-MBRD660CT-M3	75	3000	Antistatic plastic tube			
VS-MBRD660CTTR-M3	2000	2000	13" diameter reel			
VS-MBRD660CTTRL-M3	3000	3000	13" diameter reel			
VS-MBRD660CTTRR-M3	3000	3000	13" diameter reel			

LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?95627</u>				
Part marking information	www.vishay.com/doc?95176			
Packaging information	www.vishay.com/doc?95033			



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D-PAK (TO-252AA) "M"

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	IETERS	INCHES		NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	2.18	2.39	0.086	0.094	
A1	-	0.13	-	0.005	
b	0.64	0.89	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	3
С	0.46	0.61	0.018	0.024	
c2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	5
D1	5.21	-	0.205	1	3
Е	6.35	6.73	0.250	0.265	5
E1	4.32	-	0.170	-	3

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STINIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
е	2.29	BSC	0.090	BSC	
Н	9.40	10.41	0.370	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74 BSC		0.108	REF.	
L2	0.51	BSC	0.020 BSC		
L3	0.89	1.27	0.035	0.050	3
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	2
Ø	0°	10°	0°	10°	
Ø1	0°	15°	0°	15°	
Ø2	25°	35°	25°	35°	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Section C C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip
- (5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (6) Dimension b1 and c1 applied to base metal only
- (7) Datum A and B to be determined at datum plane H
- (8) Outline conforms to JEDEC® outline TO-252AA



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